

# UNR5225/5226/5227

## Silicon NPN epitaxial planar type

For muting

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$ , optimum for the muting circuit
- The use with high current value is possible

### ■ Resistance by Part Number

	Marking symbol	(R <sub>1</sub> )	(R <sub>2</sub> )
• UNR5225	FZ	10 kΩ	—
• UNR5226	FY	4.7 kΩ	—
• UNR5227	FW	6.8 kΩ	6.8 kΩ

### ■ Absolute Maximum Ratings T<sub>a</sub> = 25°C

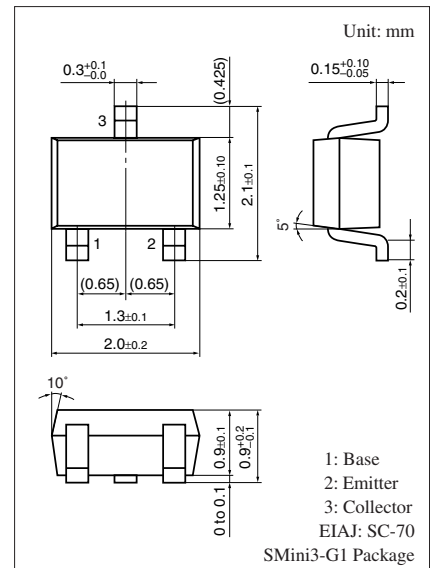
Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	30	V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V
Collector current	I <sub>C</sub>	600	mA
Total power dissipation	P <sub>T</sub>	150	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

### ■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C

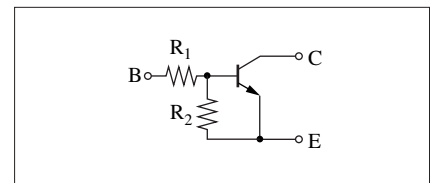
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	I <sub>C</sub> = 1 μA, I <sub>E</sub> = 0	30			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	I <sub>C</sub> = 1 mA, I <sub>B</sub> = 0	20			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	I <sub>E</sub> = 1 μA, I <sub>C</sub> = 0	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	V <sub>CB</sub> = 30 V, I <sub>E</sub> = 0			1	μA
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	V <sub>EB</sub> = 5 V, I <sub>C</sub> = 0			1	μA
Forward current transfer ratio	UNR5227	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 50 mA	70			—
	UNR5225/5226		100		600	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 50 mA, I <sub>B</sub> = 2.5 mA			80	mV
Input resistance	UNR5226	R <sub>1</sub>	-30%	4.7	+30%	kΩ
	UNR5227			6.8		
	UNR5225			10		
Resistance ratio	UNR5227	R <sub>1</sub> /R <sub>2</sub>	0.8	1.0	1.2	—
ON resistance *	UNR5226	R <sub>on</sub>		0.95		Ω
	UNR5227			1.1		
	UNR5225			1.5		
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = -50 mA, f = 200 MHz		200		MHz

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Refer to R<sub>on</sub> measurement circuit

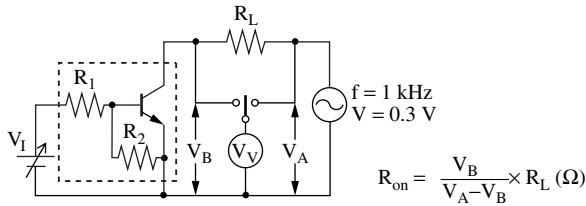


### Internal Connection

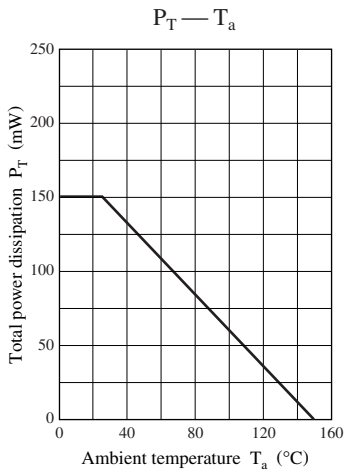


■ Electrical Characteristics (continued)  $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

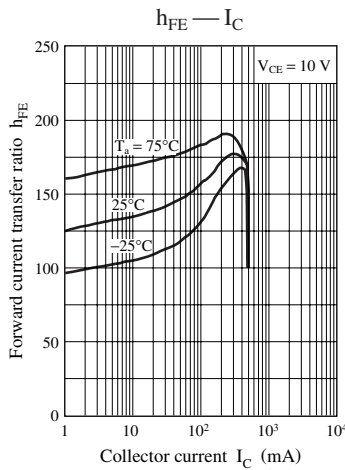
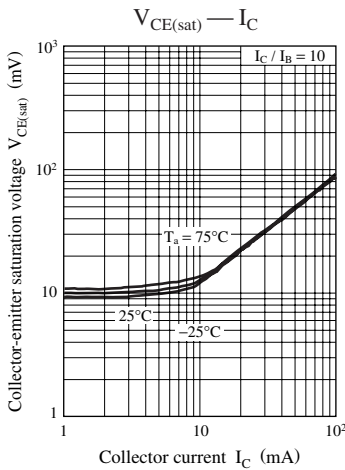
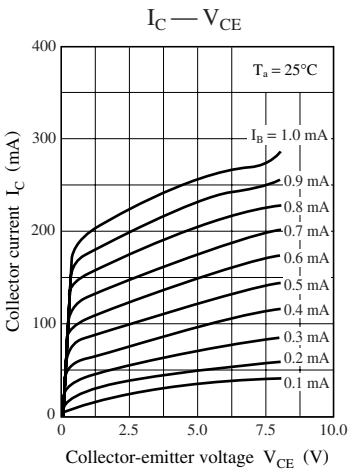
- $R_{\text{on}}$  measurement circuit

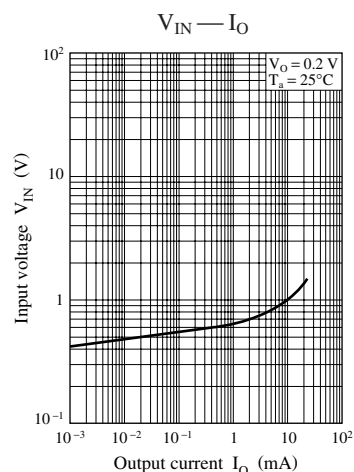
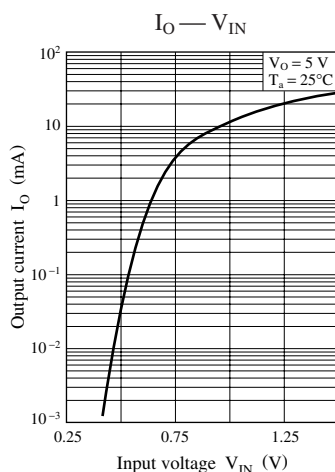
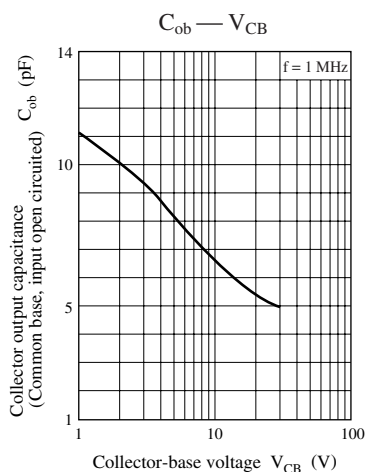


Common characteristics chart

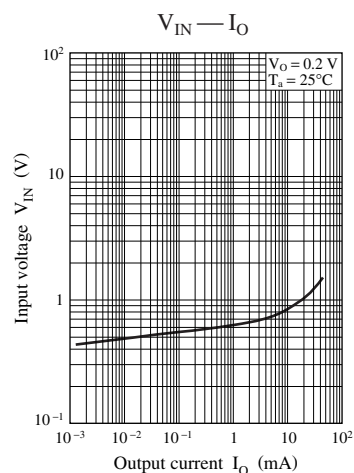
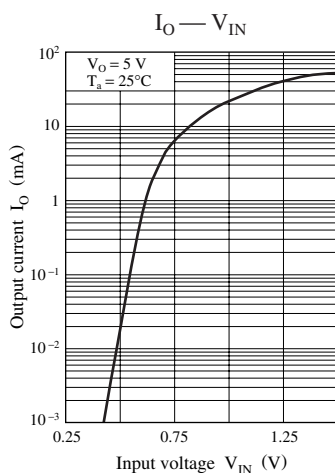
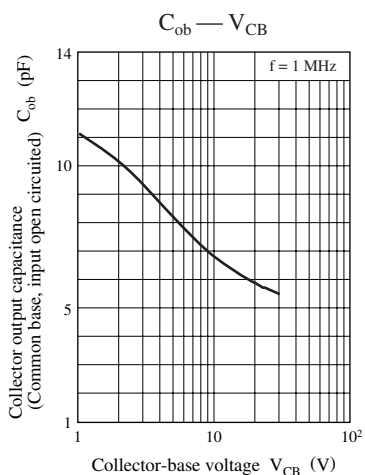
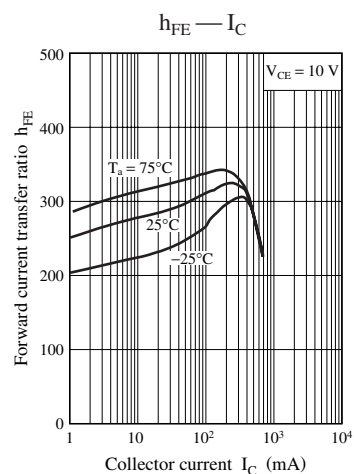
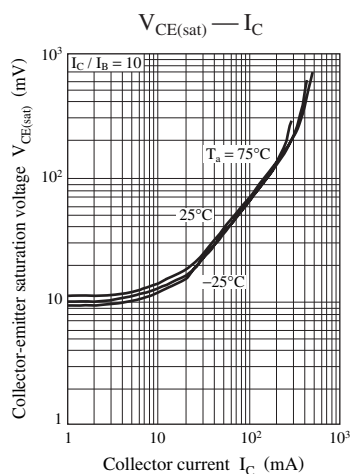
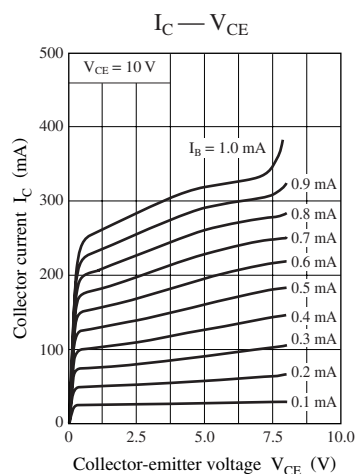


Characteristics charts of UNR5225

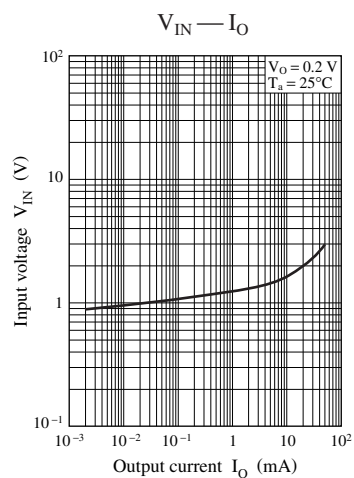
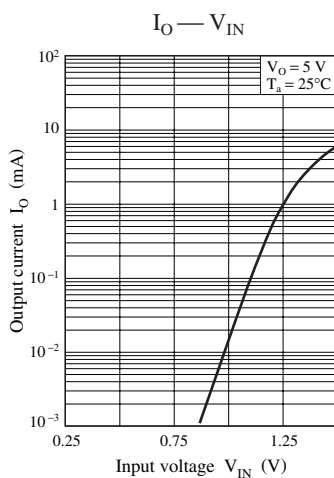
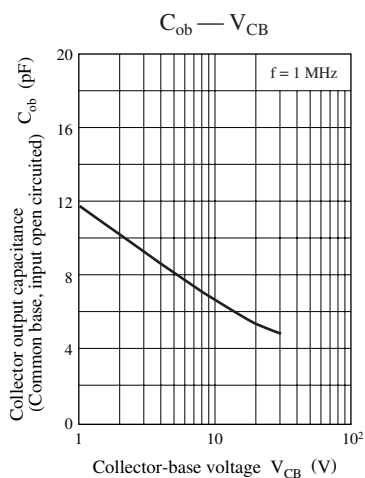
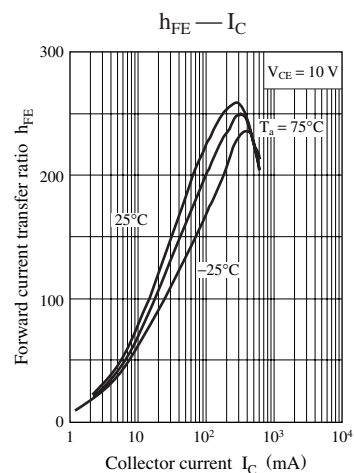
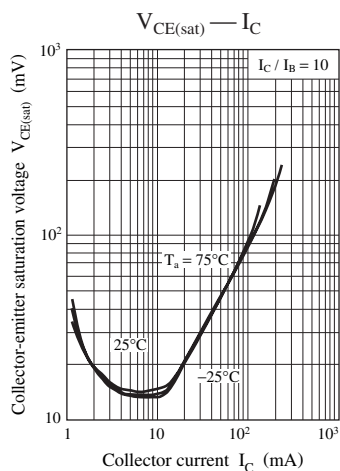
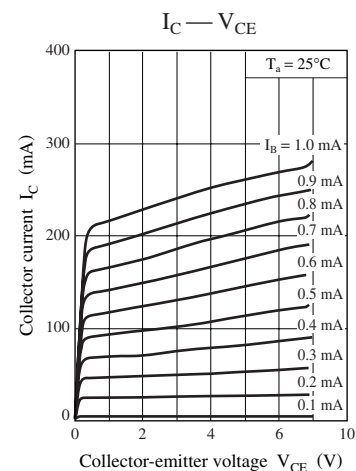




## Characteristics charts of UNR5226



## Characteristics charts of UNR5227



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